

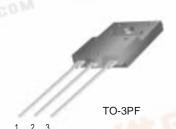
FFAF20U20DN

Features

- Ultrafast with soft recovery
- Low forward voltage

Applications

- Power switching circuits
- Output rectifiers
- Freewheeling diodes
- Switching mode power supply





1. Anode 2. Cathode 3. Anode

ULTRA FAST RECOVERY POWER RECTIFIER

Absolute Maximum Ratings (per diode) T_C=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{RRM}	Peak Repetitive Reverse Voltage	200	V
I _{F(AV)}	Average Rectified Forward Current @ T _C = 100°C	20	Α
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	200	А
T _{J,} T _{STG}	Operating Junction and StorageTemperature	- 65 to +150	°C

Thermal Characteristics

Symbol	Parameter	Value	Units	
R _{0JC}	Maximum Thermal Resistance, Junction to Case	2.1	°C/W	

Electrical Characteristics (per diode) T_C=25 °C unless otherwise noted

Symbol	Parameter		Min.	Тур	Max.	Units
V _{FM} *	Maximum Instantaneous Forward Voltage I _F = 20A I _F = 20A	T _C = 25 °C T _C = 100 °C		T V	1.2 1.0	V
RM *	Maximum Instantaneous Reverse Current @ rated V _R	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	-	-	20 200	μА
ıı D _{rr}	Maximum Reverse Recovery Time Maximum Reverse Recovery Current Maximum Reverse Recovery Charge (I _F = 20A, di/dt = 200A/µs)		- - -	- - -	40 4.0 80	ns A nC
W _{AVL}	Avalanche Energy		0.5	-	-	mJ

^{*} Pulse Test: Pulse Width=300μs, Duty Cycle=2%

Typical Characteristics

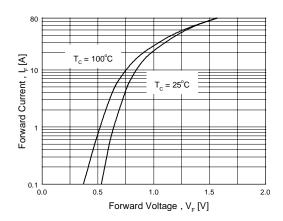


Figure 1. Typical Forward Voltage Drop vs. Forward Current

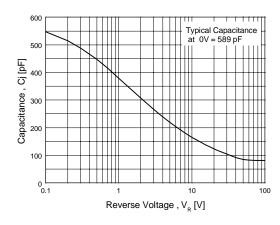


Figure 3. Typical Junction Capacitance

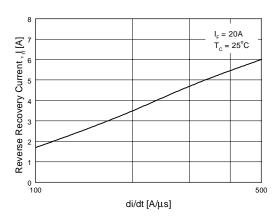


Figure 5. Typical Reverse Recovery Current vs. di/dt

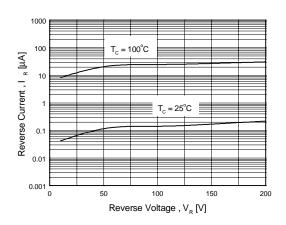


Figure 2. Typical Reverse Current vs. Reverse Voltage

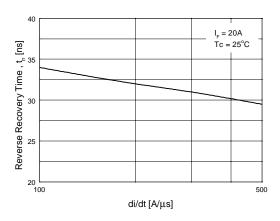


Figure 4. Typical Reverse Recovery Time vs. di/dt

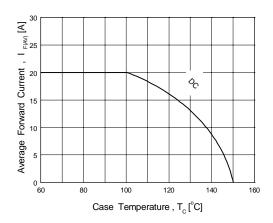
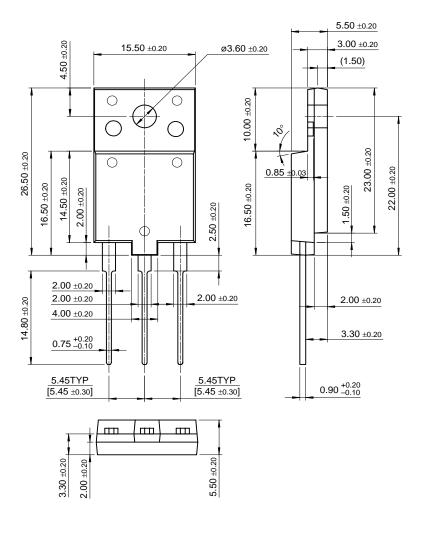


Figure 6. Forward Current Derating Curve

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Package Dimensions

TO-3PF



Dimensions in Millimeters

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